

SOT1188-2 SIL4, plastic single in-line package, 4 terminals, 1.8 mm pitch, 11 mm x 7.4 mm x 1.95 mm body 9 October 2019 Package information

Package information

Package summary 1

Terminal position code	S (single)
Package type descriptive code	SIL4
Package style descriptive code	SIP (single in-line package)
Package body material type	P (plastic)
Mounting method type	T (through-hole mount)
Issue date	23-01-2019
Manufacturer package code	SOT1188

Table 1. Package summary

Parameter	Min	Nom	Мах	Unit
package length	10.85	11	11.15	mm
package width	7.3	7.4	7.5	mm
seated height	1.85	1.95	2.05	mm
nominal pitch	-	1.8	-	mm
actual quantity of termination	-	4	-	

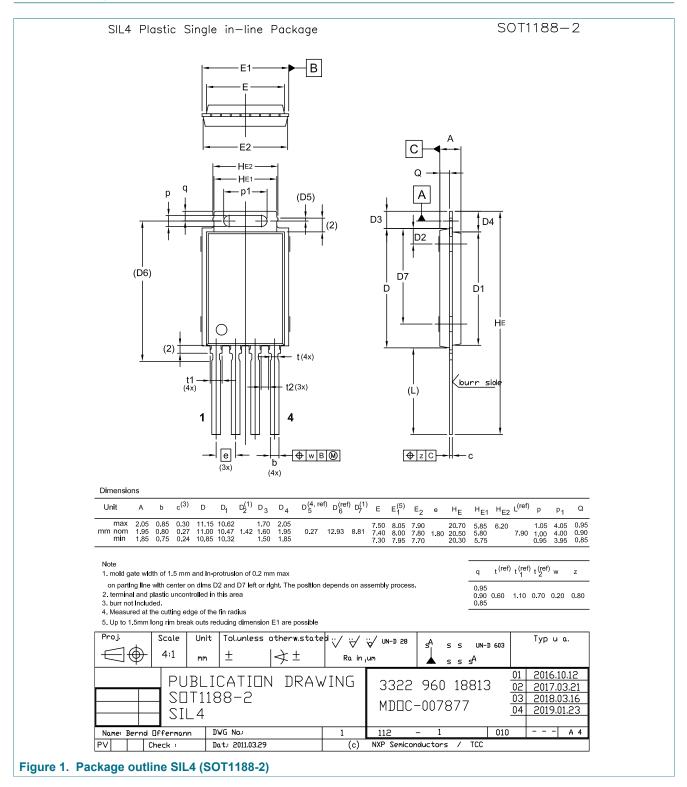


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2 Package outline



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3 Legal information

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